



## SSC65TR30GT2

### Trench FSII Fast IGBT

#### ➤ Features

$V_{CES}$	$V_{GES}$	$I_c$
650V	$\pm 20V$	60A@25°C
		30A@100°C

#### ➤ Description

- High ruggedness performance.
- 10 $\mu$ s short circuit capability.
- Positive VCE (sat) temperature coefficient.
- High efficiency for motor control.
- Excellent current sharing in parallel operation.
- RoHS complian

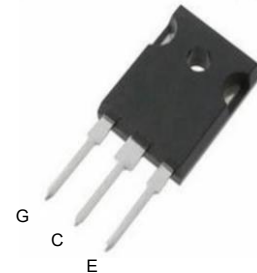
#### ➤ Applications

- Welding Machines
- PFC Circuits
- UPS
- Power Inverters

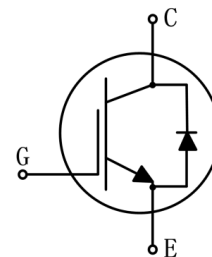
#### ➤ Ordering Information

Device	Package	Shipping
SSC65TR30GT2	TO-247-3L	30/Tube

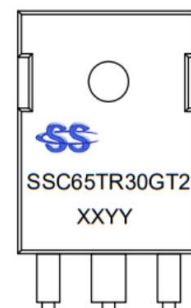
#### ➤ Pin Configuration



**TO-247-3L (Top View)**



**Pin Configuration**



**Marking**

(XYYY: Internal Traceability Code)



➤ **Absolute Maximum Ratings ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter		Ratings	Unit
$V_{CES}$	Collector-Emitter Voltage		650	V
$V_{GES}$	Gate-Emitter Voltage		$\pm 20$	V
$I_C$	Collector Current	$T_C=25^{\circ}\text{C}$	60	A
		$T_C=100^{\circ}\text{C}$	30	
$I_{Cpuls}$	Pulsed Collector Current, $t_p$ limited by $T_{vjmax}$		120	A
$P_D$	Power Dissipation <sup>a</sup>	$T_C=25^{\circ}\text{C}$	300	W
		$T_C=100^{\circ}\text{C}$	150	
$T_J$	Operating Junction and Storage Temperature Range		-40~175	$^{\circ}\text{C}$
$T_{STG}$	Operating Junction and Storage Temperature Range		-55~150	$^{\circ}\text{C}$
$t_{sc}$	Short circuit withstand time		10	us

➤ **Thermal Resistance Ratings**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance		40	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT		0.5	
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diode		0.9	

Note:

- a. The maximum current rating is package limited.



➤ **Electrical Characteristics of IGBT (T<sub>vj</sub>=25°C unless otherwise noted)**

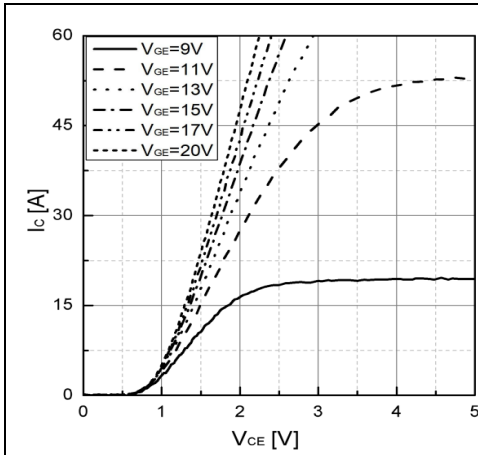
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 0.25mA	650			V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>GE</sub> =0V, V <sub>CE</sub> =650V, T <sub>vj</sub> =25°C			50	uA
I <sub>GES(F)</sub>	Gate to Emitter Forward Leakage	V <sub>GE</sub> = +20V, V <sub>CE</sub> = 0V			100	nA
I <sub>GES(R)</sub>	Gate to Emitter Reverse Leakage	V <sub>GE</sub> = -20V, V <sub>CE</sub> = 0V			-100	nA
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> =30A, V <sub>GE</sub> =15V, T <sub>vj</sub> =25°C		1.7		V
		I <sub>C</sub> =30A, V <sub>GE</sub> =15V, T <sub>vj</sub> =175°C		2.2		V
V <sub>GE(th)</sub>	Gate Threshold Voltage	I <sub>C</sub> = 1mA, V <sub>CE</sub> = V <sub>GE</sub>	5.3	5.7	5.9	V
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz		1978		pF
C <sub>oes</sub>	Output Capacitance			100		
C <sub>res</sub>	Reverse Transfer Capacitance			23		
T <sub>D(ON)</sub>	Turn-on delay time	T <sub>vj</sub> =25°C, V <sub>CC</sub> =400V, I <sub>C</sub> =30A, V <sub>GE</sub> =0/15V, R <sub>g</sub> =10Ω, Inductive Load		30		ns
T <sub>r</sub>	Rise time			39		
T <sub>D(OFF)</sub>	Turn-off delay time			151		
T <sub>f</sub>	Fall time			29		
E <sub>on</sub>	Turn-On Switching Loss			0.95		mJ
E <sub>off</sub>	Turn-Off Switching Loss			0.6		
E <sub>ts</sub>	Total Switching Loss			1.55		
T <sub>D(ON)</sub>	Turn-on delay time	T <sub>vj</sub> =175°C, V <sub>CC</sub> =400V, I <sub>C</sub> =30A, V <sub>GE</sub> =0/15V, R <sub>g</sub> =10Ω, Inductive Load		28		ns
T <sub>r</sub>	Rise time			40		
T <sub>D(OFF)</sub>	Turn-off delay time			169		
T <sub>f</sub>	Fall time			71		
E <sub>on</sub>	Turn-On Switching Loss			1.5		mJ
E <sub>off</sub>	Turn-Off Switching Loss			0.8		
E <sub>ts</sub>	Total Switching Loss			2.3		
Q <sub>G</sub>	Total Gate Charge	V <sub>CC</sub> = 520V, I <sub>C</sub> = 30A, V <sub>GE</sub> = 0/15V		103		nC



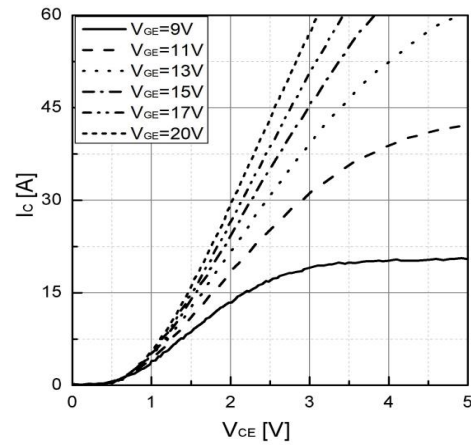
➤ **Electrical Characteristics of Diode ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VF	Diode forward voltage	IF=30A, $T_{vj}=25^{\circ}\text{C}$		1.4		V
		IF=30A, $T_{vj}=175^{\circ}\text{C}$		1.2		V
Trr	Diode reverse recovery time	VR=400V IF=30A diF/dt=550A/ $\mu\text{s}$ $T_{vj}=25^{\circ}\text{C}$		105		ns
Irrm	Diode peak reverse recovery current			16		A
Qrr	Diode reverse recovery charge			876		nC
Trr	Diode reverse recovery time	VR=400V IF=30A diF/dt=550A/ $\mu\text{s}$ $T_{vj}=175^{\circ}\text{C}$		171		ns
Irrm	Diode peak reverse recovery current			26		A
Qrr	Diode reverse recovery charge			2650		nC

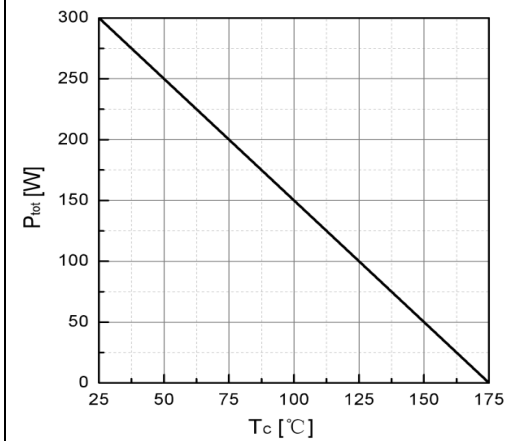
➤ **Typical Performance Characteristics ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise noted)**



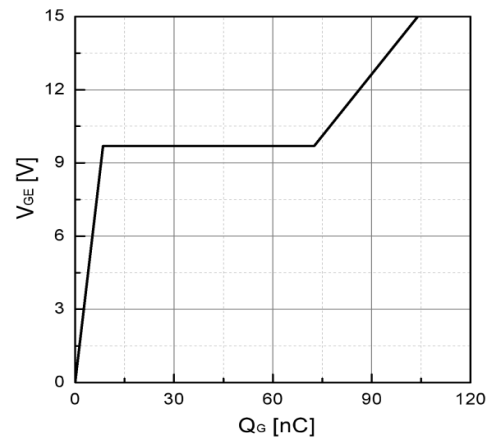
**Fig 1. Typical output characteristic ( $T_{vj}=25^{\circ}\text{C}$ )**



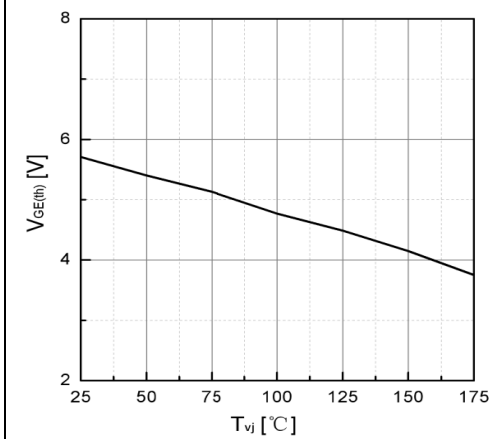
**Fig 2. Typical output characteristic ( $T_{vj}=175^{\circ}\text{C}$ )**



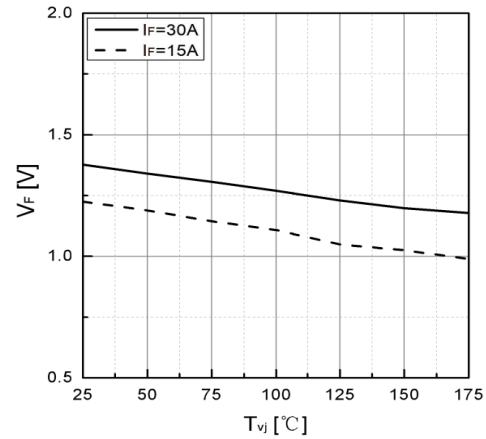
**Fig 3. Power dissipation as a function of TC**



**Fig 4. Typical Gate charge**



**Fig 5. Typical  $V_{GE(th)}$  as a function of  $T_{vj}$   
( $I_c=1\text{mA}$ )**



**Fig 6. Typical  $V_F$  as a function of  $T_{vj}$**

➤ Typical Performance Characteristics ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise noted)

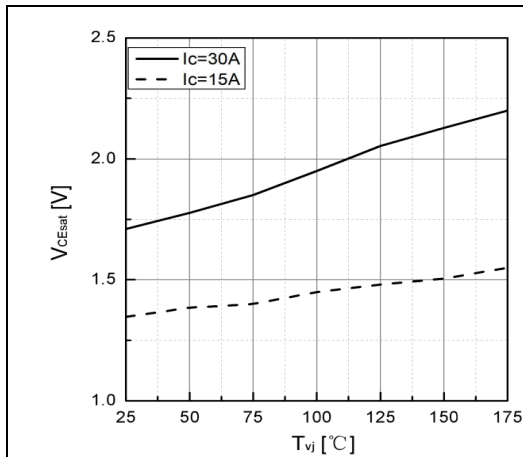


Fig 7. Typical  $V_{CEsat}$  as a function of  $T_{vj}$

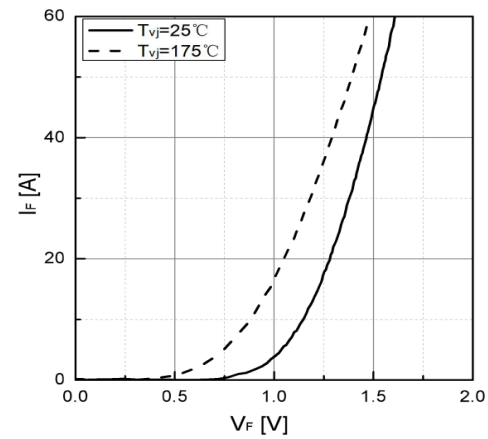


Fig 8. Typical  $I_F$  as a function of  $V_F$

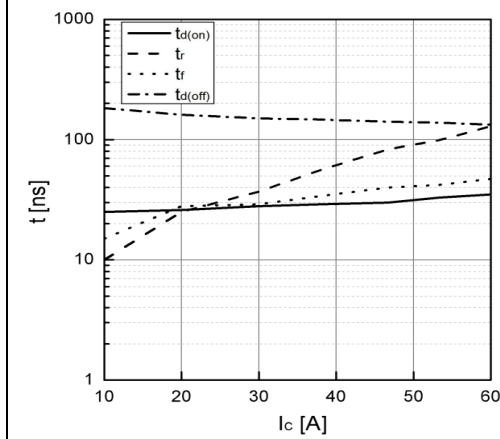


Fig 9. Typical switching time as a function of  $I_C$

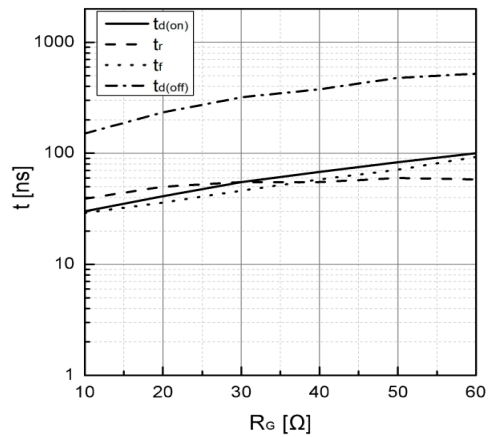


Fig 10. Typical switching times as a function of  $R_G$

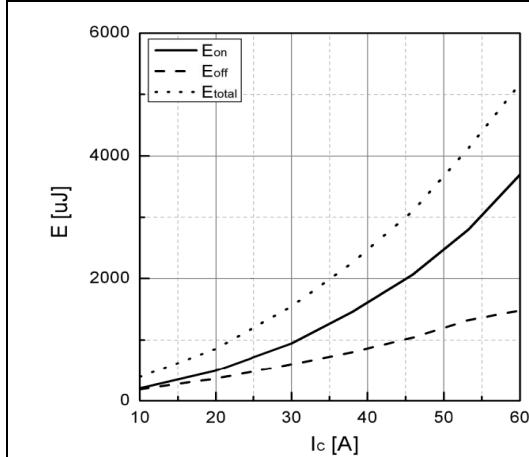


Fig 11. Typical switching energy losses as a function of  $I_C$

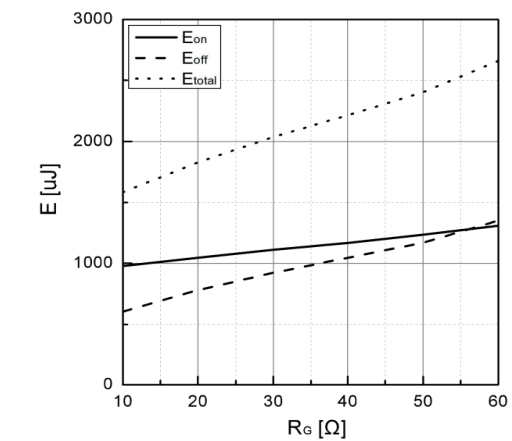
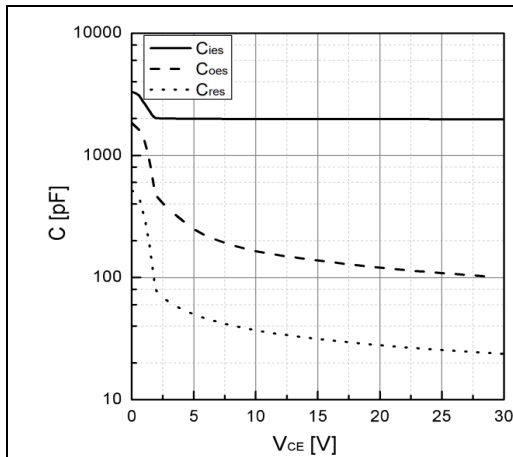
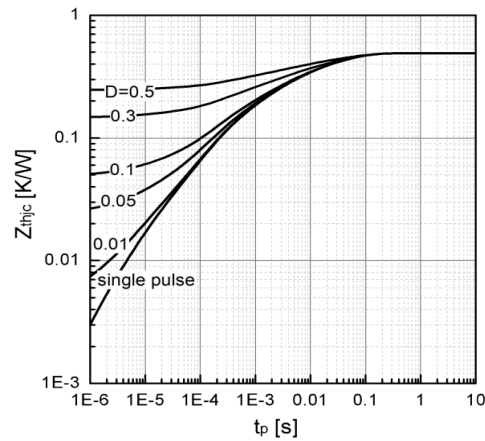


Fig 12. Typical switching times as a function of  $R_G$

➤ **Typical Performance Characteristics ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise noted)**



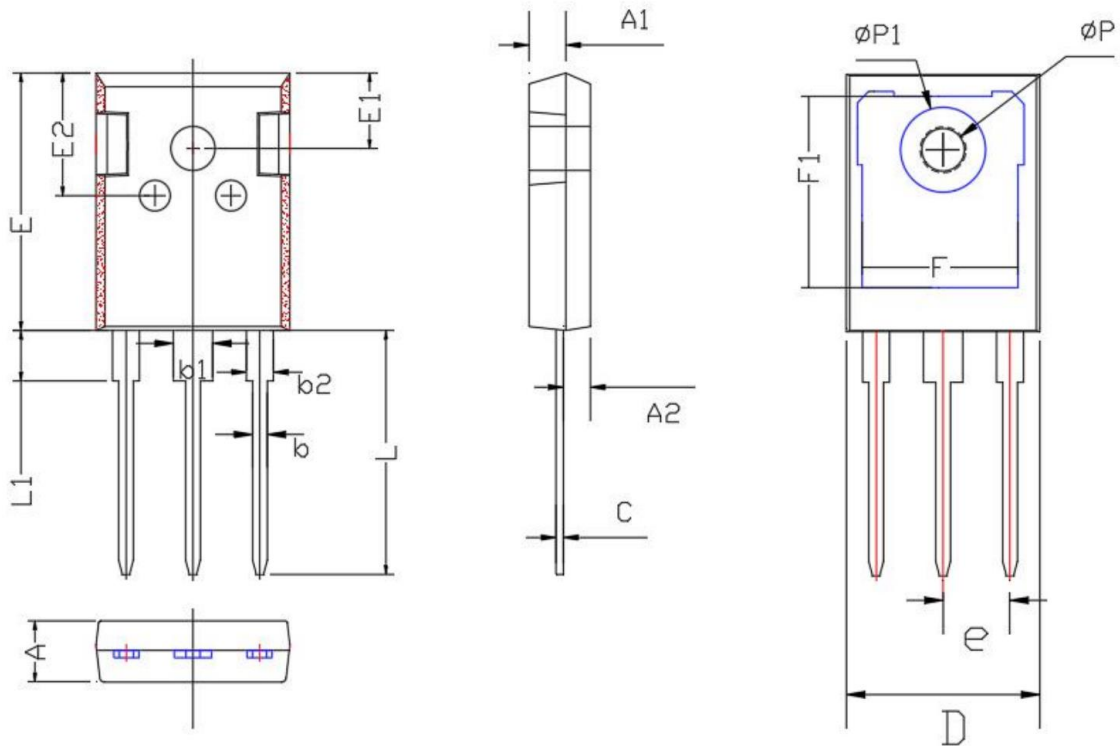
**Fig 13. Typical capacitance as a function of VCE**  
( $f=1\text{Mhz}$ ,  $V_{GE}=0\text{V}$ )



**Fig 14. Transient thermal impedance of IGBT**

## ➤ Package Information

TO247



Symbol	MILL IMETER			Symbol	MILL IMETER		
	Min	Nom	Max		Min	Nom	Max
A	4.80	5.00	5.20	E1	5.60	5.80	6.20
A1	3.30	3.50	3.70	E2	9.8	10.0	10.2
A2	2.20	2.40	2.60	e	5.25	5.45	5.65
b	1.00	1.20	1.40	F	13.1	13.4	13.7
b1	2.90	3.10	3.30	F1	16.25	16.55	16.85
b2	1.90	2.10	2.30	L	19.5	20.0	20.5
c	0.50	0.60	0.71	L1	4.00	4.20	4.40
D	15.2	15.7	16.2	P	3.30	3.50	3.80
E	20.8	21	21.2	P1	6.80	7.10	7.40





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